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PATENT ASSIGNMENT COVER SHEET

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NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SATOMI KAWAMOTO	06/29/2017
YOSHIHIDE FUKUHARA	06/29/2017
HIROMI SAITO	06/29/2017
ATSUSHI SAITO	06/29/2017
TOYOKAZU HOTCHI	06/29/2017

RECEIVING PARTY DATA

Name:	NAMICS CORPORATION
Street Address:	3993 NIGORIKAWA, KITA-KU, NIIGATA-SHI
City:	NIIGATA
State/Country:	JAPAN
Postal Code:	950-3131

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15545929

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NAME OF SUBMITTER: KAZUTO ISHIHARA

SIGNATURE: /Kazuto Ishihara/

DATE SIGNED: 12/14/2017

Total Attachments: 2

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PATENT REEL: 044396 FRAME: 0640

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PATENT REEL: 044396 FRAME: 0641

ASSIGNMENT

For good and valuable consideration received of the hereinafter named assignee, receipt of which is hereby acknowledged, the undersigned

Satomi KAWAMOTO

c/o NAMICS Corporation, 3993 Nigorikawa, Kita-ku, Niigata-shi, Niigata 950-3131 Japan

Yoshihide FUKUHARA

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c/o NAMICS Corporation, 3993 Nigorikawa, Kita-ku, Niigata-shi, Niigata 950-3131 Japan

hereby sell and assign to NAMICS Corporation having a place of business at 3993 Nigorikawa, Kita-ku, Niigata-shi, Niigata 950-3131 JAPAN, its successors and assigns, the entire right, title and interest, so far as concerns the United States and the Territories and Possessions thereof and all foreign countries, in and to the inventions entitled

FILM ADHESIVE AND SEMICONDUCTOR DEVICE INCLUDING THE SAME

for which application for United States Letters Patent has been filed on July 24, 2017 under Serial No. 15/545929 or was executed by the undersigned on the date below and is being filed concurrently herewith, said application for United States Letters Patent, any and all other applications for Letters Patent on said inventions in countries foreign to the United States, including all divisional, renewal, substitute, continuation and Convention applications based in whole or in part upon said inventions or upon said applications, and any and all Letters Patent and reissues and extensions of Letters Patent granted for said inventions or upon said applications, and every priority right that is or may be predicated upon or arise from said inventions, said applications and said Letters Patent; said assignce being hereby authorized to file patent applications in any or all countries on any or all said inventions in the name of the undersigned or in the name of said assignee or otherwise as said assignee may deem advisable, under the International Convention or otherwise; the Commissioner of Patents and Trademarks of the United States of America and the empowered officials of all other governments being hereby authorized to issue or transfer all said Letters Patent to said assignee in accordance herewith; this assignment being under covenant, not only that full power to make the same is had by the undersigned, but also that such assigned right is not encumbered by any grant, license, or other right heretofore given, and that the undersigned will do all acts reasonably serving to assure that said inventions, patent applications and Letters Patent shall be held and enjoyed by said assignee as fully and entirely as the same could have been held and enjoyed by the undersigned if this assignment had not been made, and particularly to execute and deliver to said assignee all lawful documents including petitions, specifications, oaths, assignments, invention disclaimers, and lawful affidavits in form and substance which may be requested by said assignee, to furnish said assignee with all facts relating to said inventions or the history thereof and any and all documents, photographs, models, samples or other physical exhibits which may be useful for establishing the facts of conception, disclosure and reduction to practice of said inventions, and to testify in any proceedings relating to said inventions, patent applications and Letters Patent.

The undersigned hereby appoint, request, and grant power to the following law firm to insert on this Assignment further identification which may be necessary or desirable in order to comply with the Rules of the U.S. Patent and Trademark Office for recordation of this document, for example, the U.S. Serial No. and filing date.

RANKIN, HILL & CLARK LLP, 23755 Lorain Road, Suite 200, North Olmsted, Ohio 44070-2224

Signed:	Date:
Sotomi Kawamoto	June 29, 2017
Satomi KAWAMOTO	
Signed:	Date:
Hosh Sale Dukuhara	June 29, 2017
Yoshihide FUKUHARA	
Signed:	Date:
Hiromi Saito	June 29, 2017
Hiromi SAITO	
Signed:	Date:
Arushi SAITO	June 29, 2017
Atsushi SAITO	
Signed:	Date:
Tozohogu Walv	June 29, 2017
Toyokazu HOTCHI	